

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hideji TAJIMA et al.	§	Group Art Unit: 1645
	§	
Serial Number: 10/561,550	§	Examiner: not yet assigned
	§	
Filed: December 20, 2005	§	Confirmation No.: 6278
Int'l Filing Date: June 21, 2004	§	
	§	
For: Sample Arraying/Assembly Device, Its	§	Attorney Docket Number: 10287.76
Method, and Apparatus Using Sample Assembly	§	

**POWER OF ATTORNEY AND CORRESPONDENCE ADDRESS INDICATION FORM  
BY ASSIGNEE OF ENTIRE INTEREST INCLUDING CERTIFICATION FOR  
TAKING ACTION BY ASSIGNEE UNDER 37 CFR 3.73(b)**

As a representative of the Assignee, **UNIVERSAL BIO RESEARCH CO., LTD.**, a Japanese corporation, I hereby appoint:

☒ Practitioners associated with the Customer Number:

000027683

as our attorneys and agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

☒ Please recognize or change the correspondence address for the above-identified application to:

The address associated with Customer Number:

000027683

The undersigned representative of the assignee certifies that **UNIVERSAL BIO RESEARCH CO., LTD.** is the assignee of the entire right, title and interest in the above-identified patent application by virtue of a chain of title from the inventors of the above-identified patent application to the assignee as shown on the attached Assignment document.

From: Hideji TAJIMA; Yukiko MIYASHITA; and Osamu SEGAWA

To: UNIVERSAL BIO RESEARCH CO., LTD.

The undersigned (whose title is supplied below) is authorized to act on behalf of the Assignee.

**UNIVERSAL BIO RESEARCH CO., LTD.**

Feb. 13, 2007

Date

By:

Hideji TAJIMA  
Typed or printed name

[Signature]  
Signature

President  
Title

COPY

ASSIGNMENT

WHEREAS, WE,

- |     |                         |    |                          |
|-----|-------------------------|----|--------------------------|
| (1) | <b>Hideji TAJIMA</b>    | of | Matsudo-shi, Chiba Japan |
| (2) | <b>Yukiko MIYASHITA</b> | of | Matsudo-shi, Chiba Japan |
| (3) | <b>Osamu SEGAWA</b>     | of | Matsudo-shi, Chiba Japan |

has invented certain improvements in

**SAMPLE ARRAYING/ASSEMBLING DEVICE, ITS METHOD,  
AND APPARATUS USING SAMPLE ASSEMBLY**

for which WE have executed a U.S. national phase application for Letters Patent of the United States of America, U.S. Application No. 10/561,550, filed on December 20, 2005 (International Filing Date of June 21, 2004); and

WHEREAS, **UNIVERSAL BIO RESEARCH CO., LTD.** (Assignee), a Japanese corporation, having its principal office and place of business at 88, Kamihongou, Matsudo-shi, Chiba 271-0064 Japan, is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;


NOW, THEREFORE, for One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, WE have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said **UNIVERSAL BIO RESEARCH CO., LTD.**, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and WE hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said **UNIVERSAL BIO RESEARCH CO., LTD.**, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

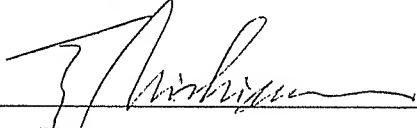
AND WE HEREBY covenant that WE have full right to convey the entire interest herein assigned, and that WE have not executed, and will not execute, any agreement in conflict herewith.

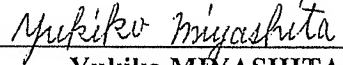
AND WE HEREBY further covenant and agree that WE will communicate to said **UNIVERSAL BIO RESEARCH CO., LTD.**, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said **UNIVERSAL BIO RESEARCH CO.**,

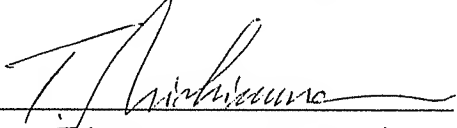
COPY


LTD., its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

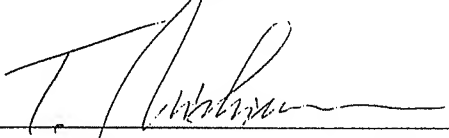
(1) Inventor:  Date: Feb. 13, 2007  
Hideo TAJIMA

Witness:  Date: Feb. 14, 2007  
TETSUJI NISHIMURA

(2) Inventor:  Date: Feb. 13<sup>th</sup>, 2007  
Yukiko MIYASHITA

Witness:  Date: Feb. 14, 2007  
TETSUJI NISHIMURA

(2) Inventor:  Date: Feb. 9, 2007  
Osamu SEGAWA

Witness:  Date: Feb. 14, 2007  
TETSUJI NISHIMURA